KEMET Part Number: C0603C229C1GACTU

(C0603C229C1GAC7867)



SMD Comm C0G, Ceramic, 2.2 pF, +/-0.25 pF, 100 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603



Dimensions		
Chip Size	0603	
L	1.6mm +/-0.15mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.07mm	
S	0.7mm MIN	
В	0.35mm +/-0.15mm	

Packaging Specifications		
Packaging:	T&R, 180mm, Paper Tape	
Packaging Quantity:	4000	

General Information		
Series:	SMD Comm C0G	
Style:	SMD Chip	
Description:	SMD, MLCC, Ultra-Stable, Low Loss, Class I	
Features:	Ultra-Stable, Low Loss, Class I	
RoHS:	Yes	
Termination:	Tin	
Marking:	No	
AEC-Q200:	No	
Component Weight:	3700 ug	
Shelf Life:	78 Weeks	
MSL:	1	

Specifications	
Capacitance:	2.2 pF
Measurement Condition:	1 MHz 1.0Vrms
Capacitance Tolerance:	+/-0.25 pF
Voltage DC:	100 VDC
Dielectric Withstanding Voltage:	250 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor:	0.1% 1 MHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	100 GOhms

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